Low-ohmic single-pole double-throw analog switch

Rev. 6 — 8 November 2011

Product data sheet

1. General description

The NX3L1T5157 is a low-ohmic single-pole double-throw analog switch suitable for use as an analog or digital 2:1 multiplexer/demultiplexer. It has a digital select input (S), two independent inputs/outputs (Y0 and Y1) and a common input/output (Z).

Schmitt trigger action at the digital input makes the circuit tolerant to slower input rise and fall times. Low threshold digital input allows this device to be driven by 1.8 V logic levels in 3.3 V applications without significant increase in supply current I_{CC}. This makes it possible for the NX3L1T5157 to switch 4.3 V signals with a 1.8 V digital controller, eliminating the need for logic level translation. The NX3L1T5157 allows signals with amplitude up to V_{CC} to be transmitted from Z to Y0 or Y1, or from Y0 or Y1 to Z. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at V_{CC} = 1.4 V
 - 1.0 Ω (typical) at V_{CC} = 1.65 V
 - 0.55 Ω (typical) at V_{CC} = 2.3 V
 - 0.50 Ω (typical) at V_{CC} = 2.7 V
 - 0.50 Ω (typical) at V_{CC} = 4.3 V
- Break-before-make switching
- High noise immunity
- ESD protection:
 - HBM JESD22-A114F Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - CDM AEC-Q100-011 revision B exceeds 1000 V
 - IEC61000-4-2 contact discharge exceeds 8000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD78 Class II Level A
- 1.8 V control logic at V_{CC} = 3.6 V
- Control input accepts voltages above supply voltage
- Very low supply current, even when input is below V_{CC}
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C



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3. Applications

- Cell phone
- PDA
- Portable media player

4. Ordering information

Table 1. Ordering information	
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Type number	Package							
	Temperature range	Name	Description	Version				
NX3L1T5157GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886				

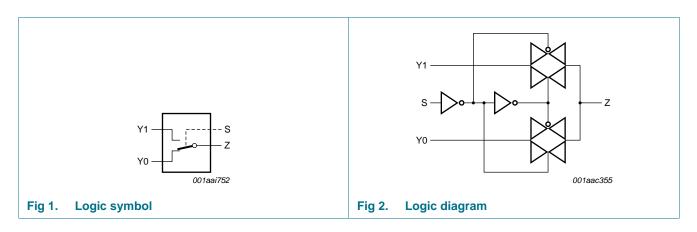
5. Marking

Table 2.	Marking codes ^[1]	
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Type number	Marking code
NX3L1T5157GM	DI

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

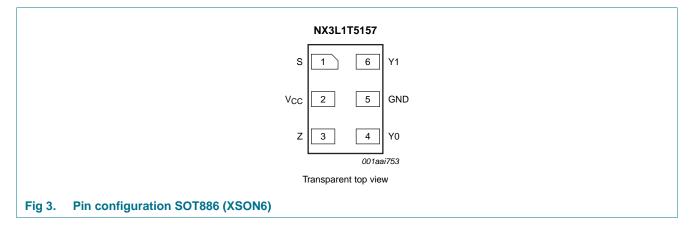
6. Functional diagram



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7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
S	1	select input
V _{CC}	2	supply voltage
Z	3	common input or output
Y0	4	independent input or output
GND	5	ground (0 V)
Y1	6	independent input or output

8. Functional description

Table 4.Function table^[1]

Input S	Channel on
L	YO
Н	Y1

[1] H = HIGH voltage level; L = LOW voltage level.

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9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	select input S	<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		[2] _0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	$V_{l} < -0.5 V$	-50	-	mA
I _{SK}	switch clamping current	$V_l < -0.5$ V or $V_l > V_{CC}$ + 0.5 V	-	±50	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[3] _	250	mW

[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

[3] For XSON6 package: above 118 °C the value of Ptot derates linearly with 7.8 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

	1 0				
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		1.4	4.3	V
VI	input voltage	select input S	0	4.3	V
V _{SW}	switch voltage		<u>[1]</u> 0	V _{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$	[2] _	200	ns/V

[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Yn. In this case, there is no limit for the voltage drop across the switch.

[2] Applies to control signal levels.

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11. Static characteristics

Table 7. Static characteristics

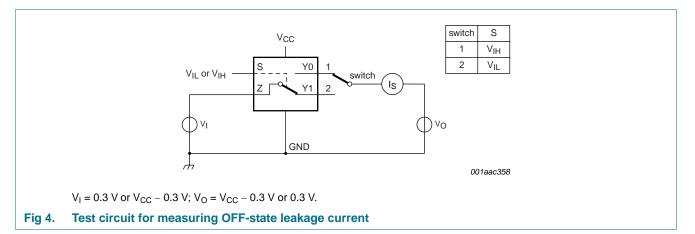
At recommended operating conditions; voltages are referenced to GND (ground 0 V).

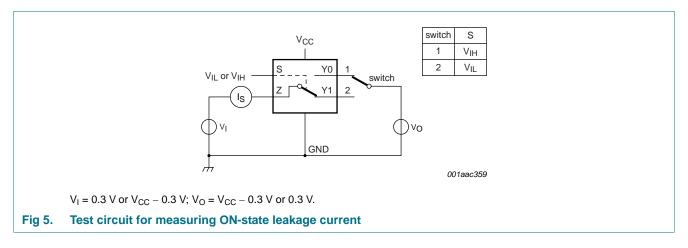
Symbol	Parameter	Conditions	T,	T _{amb} = 25 °C			T _{amb} = -40 °C to +125 °C		
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
VIH	HIGH-level	$V_{CC} = 1.4 \text{ V}$ to 1.6 V	0.9	-	-	0.9	-	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	0.9	-	-	0.9	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.1	-	-	1.1	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	1.3	-	-	1.3	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	1.4	-	-	1.4	-	-	V
V _{IL}	LOW-level	V_{CC} = 1.4 V to 1.6 V	-	-	0.3	-	0.3	0.3	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	0.4	-	0.4	0.3	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.4	-	0.4	0.4	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.5	-	0.5	0.5	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	0.6	-	0.6	0.6	V
I	input leakage current	select input S; V _I = GND to 4.3 V; V _{CC} = 1.4 V to 4.3 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	Y0 and Y1 port; see <u>Figure 4</u>							
		V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		V_{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I _{S(ON)}	ON-state leakage current	Z port; see Figure 5							
		V_{CC} = 1.4 V to 3.6 V	-	-	±5	-	±50	±500	nA
		V_{CC} = 3.6 V to 4.3 V	-	-	±10	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}							
		$V_{CC} = 3.6 V$	-	-	100	-	690	6000	nA
		$V_{CC} = 4.3 V$	-	-	150	-	800	7000	nA
∆l _{CC}	additional	V_{SW} = GND or V_{CC}							
	supply current	$V_{I} = 2.6 V; V_{CC} = 4.3 V$	-	2.0	4.0	-	7	7	μΑ
		$V_{I} = 2.6 V; V_{CC} = 3.6 V$	-	0.35	0.7	-	1	1	μΑ
		$V_{I} = 1.8 V; V_{CC} = 4.3 V$	-	7.0	10.0	-	15	15	μΑ
		$V_{I} = 1.8 \text{ V}; V_{CC} = 3.6 \text{ V}$	-	2.5	4.0	-	5	5	μΑ
		$V_{I} = 1.8 V; V_{CC} = 2.5 V$	-	50	200	-	300	500	nA
CI	input capacitance		-	1.0	-	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	130	-	-	-	-	pF

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11.1 Test circuits





11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 13.

Symbol	Parameter	rameter Conditions		–40 °C to	o +85 °C	$T_{amb} = -40$ °	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
On (peak)	ON resistance (peak)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100$ mA; see <u>Figure 6</u>						
		V _{CC} = 1.4 V	-	1.6	3.7	-	4.1	Ω
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω
		V _{CC} = 2.3 V	-	0.55	0.8	-	0.9	Ω
		V _{CC} = 2.7 V	-	0.5	0.75	-	0.9	Ω
		$V_{CC} = 4.3 V$	-	0.5	0.75	-	0.9	Ω

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Symbol	Parameter	Conditions		T _{amb} = -40 °C to +85 °C			T _{amb} = -40 °	C to +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
ΔR_{ON}	ON resistance mismatch	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$	[2]					'	
	between channels	$V_{CC} = 1.4 V$		-	0.04	0.3	-	0.3	Ω
	Channels	V _{CC} = 1.65 V		-	0.04	0.2	-	0.3	Ω
		$V_{CC} = 2.3 V$		-	0.02	0.08	-	0.1	Ω
		$V_{CC} = 2.7 V$		-	0.02	0.075	-	0.1	Ω
		$V_{CC} = 4.3 V$		-	0.02	0.075	-	0.1	Ω
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND$ to V_{CC} ; $I_{SW} = 100 \text{ mA}$	<u>[3]</u>						
		$V_{CC} = 1.4 V$		-	1.0	3.3	-	3.6	Ω
		V _{CC} = 1.65 V		-	0.5	1.2	-	1.3	Ω
		$V_{CC} = 2.3 V$		-	0.15	0.3	-	0.35	Ω
		$V_{CC} = 2.7 V$		-	0.13	0.3	-	0.35	Ω
		$V_{CC} = 4.3 V$		-	0.2	0.4	-	0.45	Ω

Table 8. ON resistance ...continued

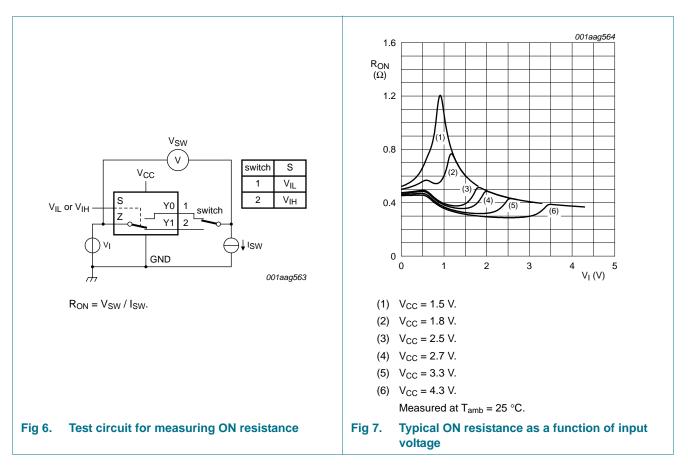
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 13.

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] Measured at identical V_{CC}, temperature and input voltage.

[3] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

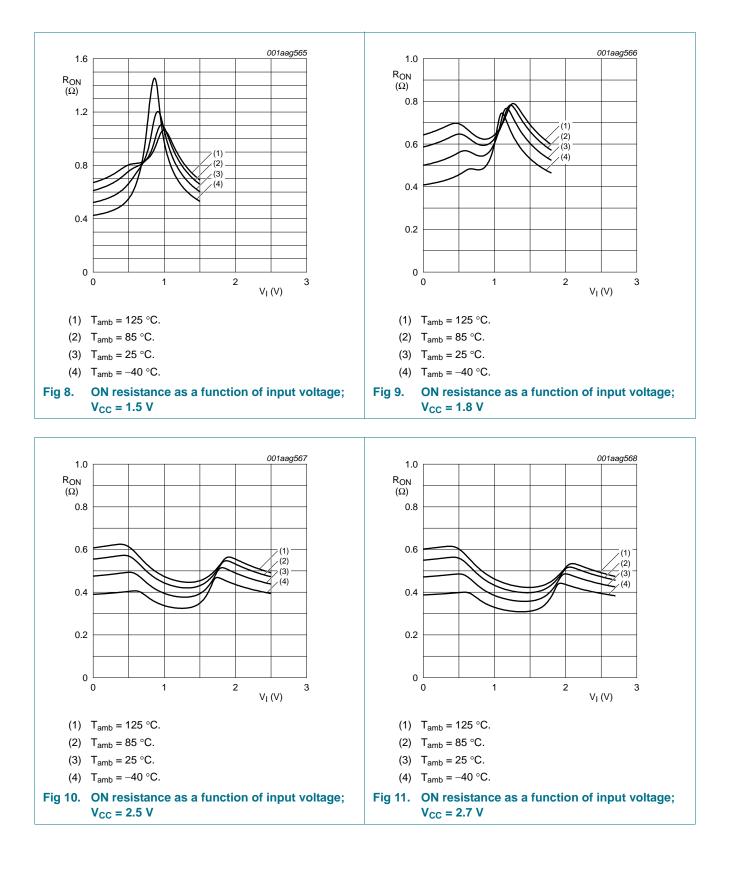
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11.3 ON resistance test circuit and graphs

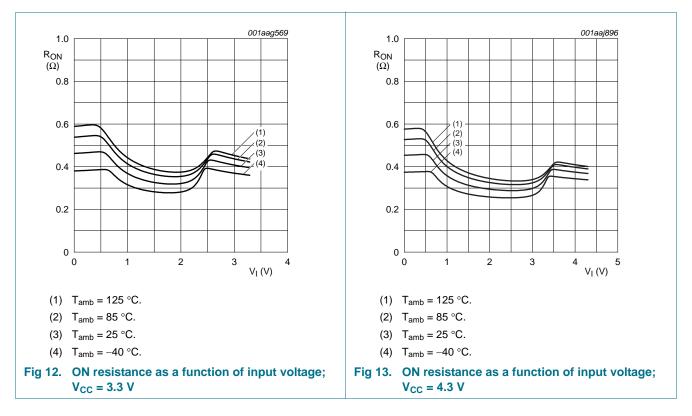
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12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

Symbol	Parameter	Conditions		25 °C		-40	Unit		
			Min	Typ <mark>[1]</mark>	Max	Min	Max (85 °C)	Max (125 °C)	-
t _{en}	enable time	S to Z or Yn; see <u>Figure 14</u>							
		V_{CC} = 1.4 V to 1.6 V	-	50	90	-	120	120	ns
		V _{CC} = 1.65 V to 1.95 V	-	36	70	-	80	90	ns
		V_{CC} = 2.3 V to 2.7 V	-	24	45	-	50	55	ns
		V_{CC} = 2.7 V to 3.6 V	-	22	40	-	45	50	ns
		V_{CC} = 3.6 V to 4.3 V	-	22	40	-	45	50	ns
t _{dis}	disable time	S to Z or Yn; see <u>Figure 14</u>							
		V_{CC} = 1.4 V to 1.6 V	-	32	70	-	80	90	ns
		V_{CC} = 1.65 V to 1.95 V	-	20	55	-	60	65	ns
		V_{CC} = 2.3 V to 2.7 V	-	12	25	-	30	35	ns
		V_{CC} = 2.7 V to 3.6 V	-	10	20	-	25	30	ns
		V_{CC} = 3.6 V to 4.3 V	-	10	20	-	25	30	ns

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Symbol	Parameter	Conditions		25 °C			–40 °C to +125 °C			Unit
		-		Min	Typ <mark>[1]</mark>	Мах	Min	Max (85 °C)	Max (125 °C)	
t _{b-m}	break-before-make time	see Figure 15	[2]							
		$V_{CC} = 1.4 \text{ V} \text{ to } 1.6 \text{ V}$		-	19	-	9	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		-	17	-	7	-	-	ns
		V_{CC} = 2.3 V to 2.7 V		-	13	-	4	-	-	ns
		V_{CC} = 2.7 V to 3.6 V		-	10	-	3	-	-	ns
		V_{CC} = 3.6 V to 4.3 V		-	10	-	2	-	-	ns

Table 9. Dynamic characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 16.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

[2] Break-before-make guaranteed by design.

12.1 Waveform and test circuits

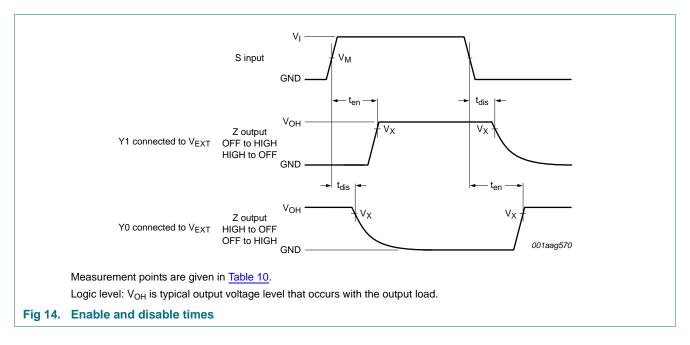
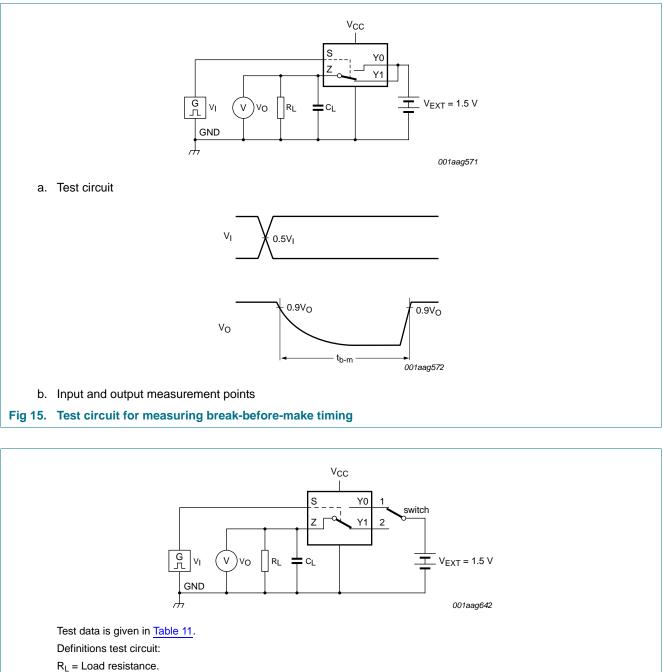


Table 10. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _X
1.4 V to 4.3 V	0.5V _{CC}	0.9V _{OH}

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RL = Loau resistance.

- C_L = Load capacitance including jig and probe capacitance.
- V_{EXT} = External voltage for measuring switching times.

Fig 16. Load circuit for switching times

Table 11. Test data

Supply voltage	Input		Load		
V _{cc}	VI	t _r , t _f	CL	RL	
1.4 V to 4.3 V	V _{CC}	\leq 2.5 ns	35 pF	50 Ω	

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12.2 Additional dynamic characteristics

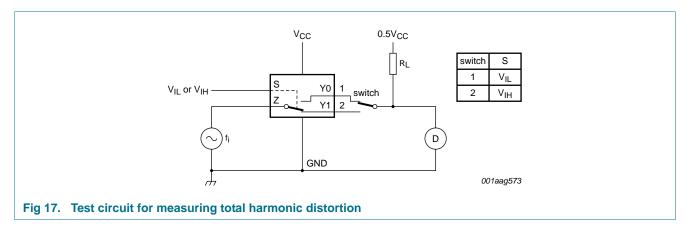
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_1 = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 2.5 \text{ ns}$; $T_{amb} = 25 \text{ °C}$.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
THD	total harmonic	$f_i = 20 \text{ Hz to } 20 \text{ kHz}; \text{ R}_L = 32 \Omega; \text{ see } \frac{\text{Figure } 17}{1000 \text{ sec } 17}$	[1]			
	distortion	V _{CC} = 1.4 V; V _I = 1 V (p-p)	-	0.15	-	%
		V _{CC} = 1.65 V; V _I = 1.2 V (p-p)	-	0.10	- - - - - - - - - - - - - - - - - - -	%
		V _{CC} = 2.3 V; V _I = 1.5 V (p-p)	-	0.02	-	%
	$\begin{array}{c} V_{CC} = 1.65 \text{ V; } V_{I} = 1.2 \text{ V (p-p)} \\ \hline V_{CC} = 2.3 \text{ V; } V_{I} = 1.5 \text{ V (p-p)} \\ \hline V_{CC} = 2.7 \text{ V; } V_{I} = 2 \text{ V (p-p)} \\ \hline V_{CC} = 4.3 \text{ V; } V_{I} = 2 \text{ V (p-p)} \\ \hline V_{CC} = 4.3 \text{ V; } V_{I} = 2 \text{ V (p-p)} \\ \hline V_{CC} = 1.4 \text{ V to } 4.3 \text{ V} \\ \hline \text{isolation (OFF-state)} & f_{i} = 100 \text{ kHz; } R_{L} = 50 \Omega; \text{ see Figure 19} \\ \hline f_{i} = 100 \text{ kHz; } R_{L} = 50 \Omega; \text{ see Figure 19} \\ \hline V_{CC} = 1.4 \text{ V to } 4.3 \text{ V} \\ \hline \text{crosstalk voltage} & between digital inputs and switch; \\ f_{i} = 1 \text{ MHz; } C_{L} = 50 \text{ pF; } R_{L} = 50 \Omega; \text{ see Figure 20} \\ \hline V_{CC} = 1.4 \text{ V to } 3.6 \text{ V} \\ \hline V_{CC} = 3.6 \text{ V to } 4.3 \text{ V} \\ \hline \end{array}$	-	0.02	-	%	
		V _{CC} = 4.3 V; V _I = 2 V (p-p)	-	0.02	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 18	<u>[1]</u>			
	response	$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$	-	60	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 100 \text{ kHz}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 19}}{100 \text{ kHz}}$	<u>[1]</u>			
		$V_{CC} = 1.4 \text{ V} \text{ to } 4.3 \text{ V}$	-	-90	-	dB
V _{ct}	crosstalk voltage					
		V _{CC} = 1.4 V to 3.6 V	-	0.2	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	0.3	-	V
Q _{inj}	charge injection	$f_i = 1 \text{ MHz}; C_L = 0.1 \text{ nF}; R_L = 1 \text{ M}\Omega; V_{gen} = 0 \text{ V}; R_{gen} = 0 \Omega; \text{ see } \frac{\text{Figure 21}}{2}$				
		V _{CC} = 1.5 V	-	3	-	рС
		V _{CC} = 1.8 V	-	4	-	рС
		$V_{CC} = 2.5 V$	-	6	-	рС
		V _{CC} = 3.3 V	-	9	-	рС
		$V_{CC} = 4.3 V$	-	15	-	рС

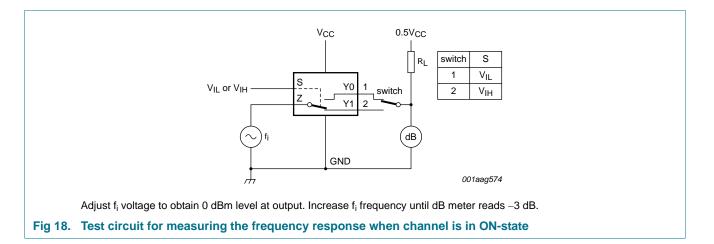
[1] f_i is biased at 0.5V_{CC}.

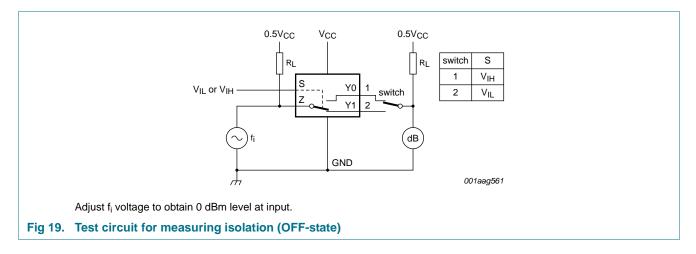
12.3 Test circuits

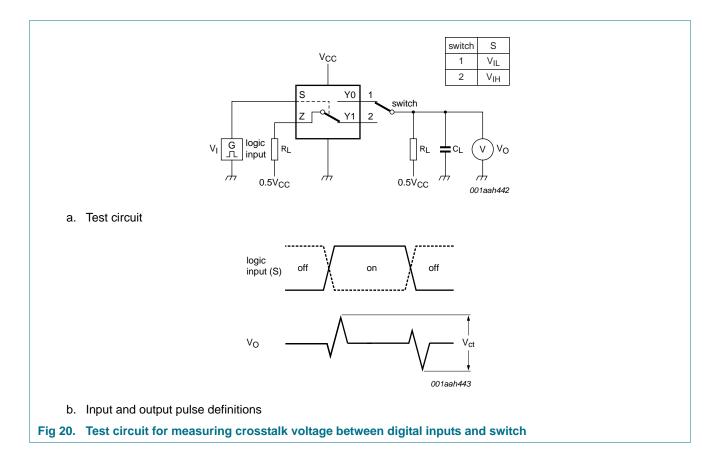


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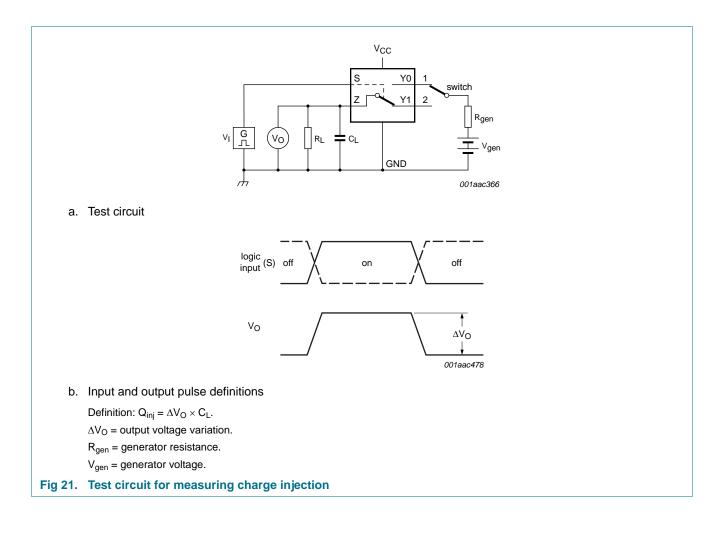
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NX3L1T5157



NX3L1T5157

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13. Package outline

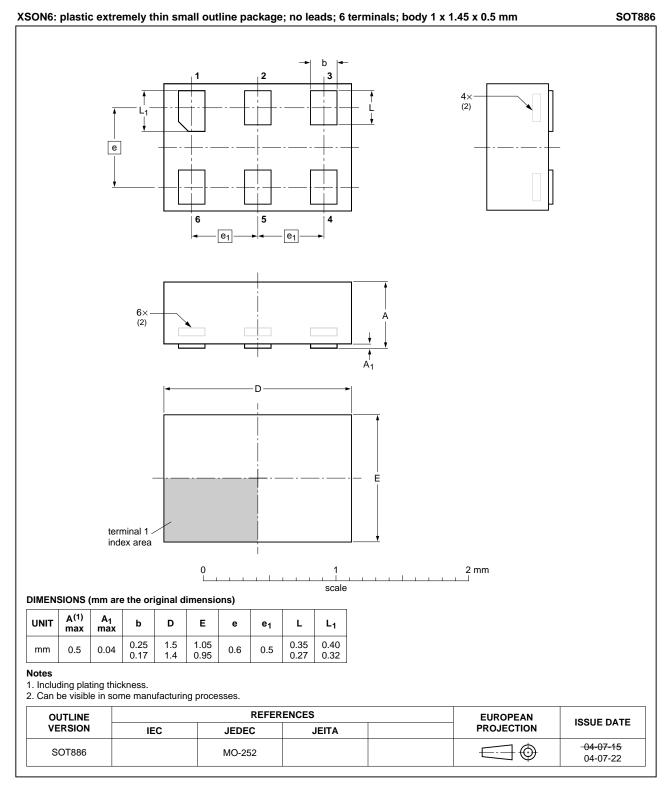


Fig 22. Package outline SOT886 (XSON6)

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14. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant

15. Revision history

Table 14. Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L1T5157 v.6	20111108	Product data sheet	-	NX3L1T5157 v.5
Modifications:	 Legal pages 	s updated.		
NX3L1T5157 v.5	20110728	Product data sheet	-	NX3L1T5157 v.4
NX3L1T5157 v.4	20100324	Product data sheet	-	NX3L1T5157 v.3
NX3L1T5157 v.3	20100208	Product data sheet	-	NX3L1T5157 v.2
NX3L1T5157 v.2	20090417	Product data sheet	-	NX3L1T5157 v.1
NX3L1T5157 v.1	20080916	Product data sheet	-	-

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16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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